

MiniSKiiP<sup>®</sup> 1

3-phase bridge inverter

#### SKiiP 11AC126V1

### Features

- Fast Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

#### **Typical Applications**

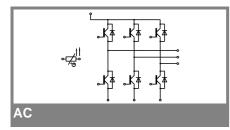
- Inverter up to 8 kVA
- Typical motor power 4 kW

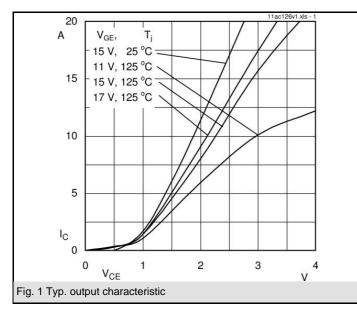
### Remarks

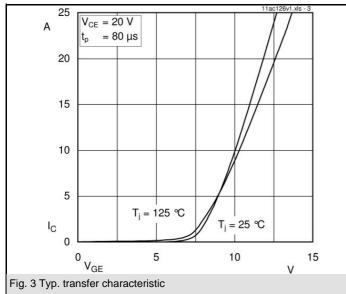
•  $V_{CEsat}$ ,  $V_F$ = chip level value

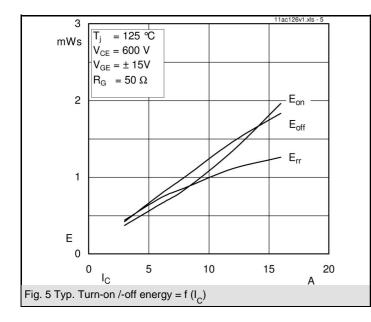
Absolute	Maximum Ratings	T <sub>s</sub> = 25 °C, unless otherwise sp	= 25 °C, unless otherwise specified					
Symbol	Conditions	Values	Units					
IGBT - Inverter								
V <sub>CES</sub>		1200	V					
I <sub>C</sub>	T <sub>s</sub> = 25 (70) °C	16 (15)	Α					
I <sub>CRM</sub>	$t_p \le 1 \text{ ms}$	16	Α					
V <sub>GES</sub>		± 20	V					
Т <sub>ј</sub>		- 40 + 150	°C					
Diode - Inverter								
I <sub>F</sub>	T <sub>s</sub> = 25 (70) °C	14 (11)	Α					
I <sub>FRM</sub>	$t_p \le 1 \text{ ms}$	16	А					
Т <sub>ј</sub>		- 40 + 150	°C					
I <sub>tRMS</sub>	per power terminal (20 A / spring)	40	Α					
T <sub>stg</sub>	$T_{op} \leq T_{stg}$	- 40 + 125	°C					
V <sub>isol</sub>	AC, 1 min.	2500	V					

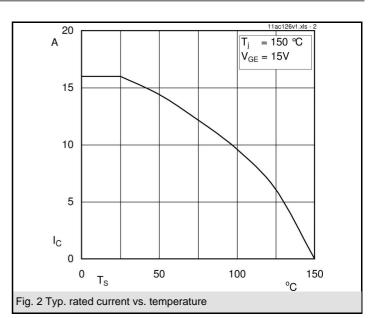
Characte	ristics	T <sub>s</sub> = 25 °C,	$T_s$ = 25 °C, unless otherwise specified					
Symbol	Conditions	min.	typ.	max.	Units			
IGBT - Inverter								
V <sub>CEsat</sub>	I <sub>Cnom</sub> = 8 A, T <sub>j</sub> = 25 (125) °C		1,7 (2)	2,1 (2,4)	V			
V <sub>GE(th)</sub>	$V_{GE} = V_{CE}, I_{C} = 0.3 \text{ mA}$	5	5,8	6,5	V			
V <sub>CE(TO)</sub>	T <sub>j</sub> = 25 (125) °C		1 (0,9)	1,2 (1,1)	V			
r <sub>T</sub>	T <sub>j</sub> = 25 (125) °C		87 (138)	113 (162)	mΩ			
C <sub>ies</sub>	V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V, f = 1 MHz		0,7		nF			
C <sub>oes</sub>	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		0,1		nF			
C <sub>res</sub>	V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V, f = 1 MHz		0,1		nF			
R <sub>th(j-s)</sub>	per IGBT		1,5		K/W			
t <sub>d(on)</sub>	under following conditions		20		ns			
t <sub>r</sub> `´	$V_{CC}$ = 600 V, $V_{GE}$ = ± 15 V		20		ns			
t <sub>d(off)</sub>	I <sub>Cnom</sub> = 8 A, T <sub>j</sub> = 125 °C		390		ns			
t <sub>f</sub>	$R_{Gon} = R_{Goff} = 50 \ \Omega$		105		ns			
Eon	inductive load		0,9		mJ			
E <sub>off</sub>			1		mJ			
Diode - Ir	verter							
V <sub>F</sub> = V <sub>EC</sub>	I <sub>Fnom</sub> = 8 A, T <sub>j</sub> = 25 (125) °C		1,9 (2)	2,2 (2,4)	V			
V <sub>(TO)</sub>	T <sub>i</sub> = 25 (125) °C		1 (0,8)	1,1 (0,9)	V			
r <sub>T</sub>	T <sub>j</sub> = 25 (125) °C		112 (150)	138 (187)	mΩ			
R <sub>th(j-s)</sub>	per diode		2,5		K/W			
I <sub>RRM</sub>	under following conditions		15		Α			
Q <sub>rr</sub>	I <sub>Fnom</sub> = 8 A, V <sub>R</sub> = 600 V		1,8		μC			
E <sub>rr</sub>	V <sub>GE</sub> = 0 V, T <sub>i</sub> = 125 °C		0,9		mJ			
	di <sub>F</sub> /dt = 750 A/µs							
Tempera	Temperature Sensor							
R <sub>ts</sub>	3 %, T <sub>r</sub> = 25 (100) °C		1000(1670)		Ω			
Mechanic	cal Data	I						
m			35		g			
M <sub>s</sub>	Mounting torque	2		2,5	Nm			
					1			

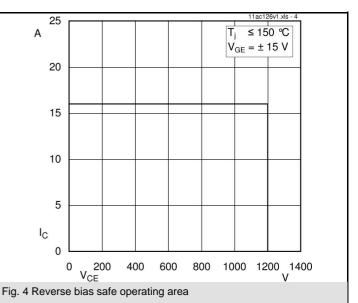


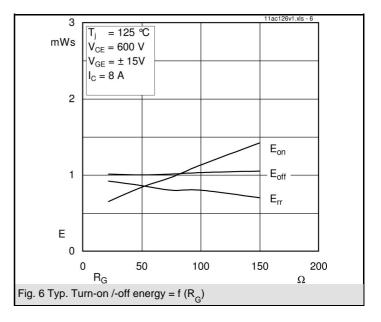


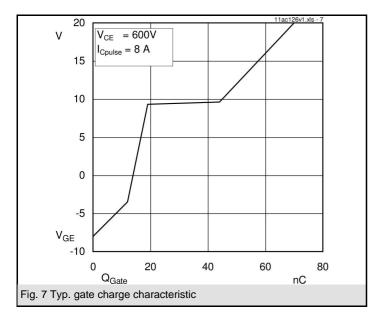


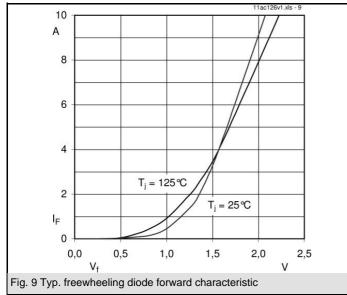


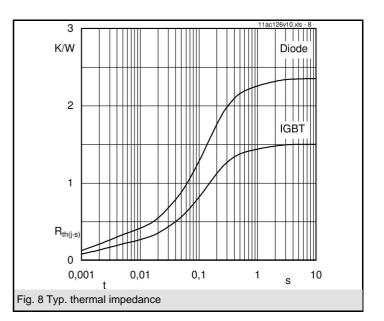


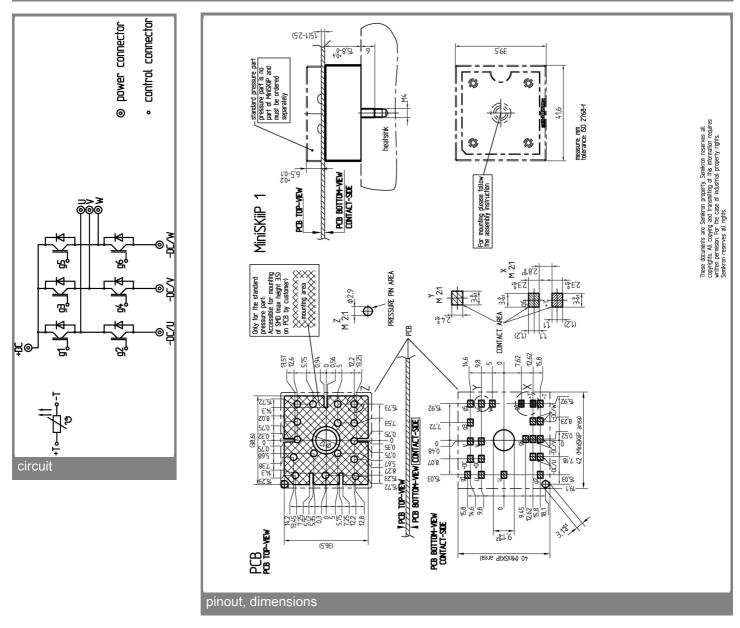












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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